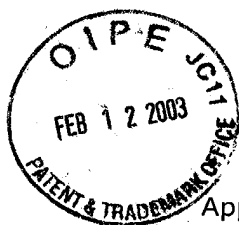


MAT-8165US

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: S. Maezawa et al. : Art Unit: 2827
Serial No.: 09/913,372 : Examiner: I. B. Patel
Filed: November 27, 2001 :
FOR: MULTILAYER PRINTED WIRING BOARD AND :
ITS MANUFACTURING METHOD (AS :
AMENDED) :

AMENDMENT

Assistant Commissioner for Patents
Washington, DC 20231

S I R :

Responsive to the Official Action dated **November 6, 2002**, please amend the above-identified application as follows:

IN THE TITLE:

Please replace the Title with the following:

MULTILAYER PRINTED WIRING BOARD AND ITS MANUFACTURING METHOD

IN THE DRAWINGS:

Please replace Figs. 1-3 with new Figs. 1(a)-1(d), 2(a)-2(d), and 3(a)-3(f).

IN THE CLAIMS:

Please cancel claims 11-17, 24-26 and 30-35.

Please replace claims 1, 18-23 and 27-29 with the following amended claims:

- 1 1. (Amended) A multilayer printed wiring board comprising:

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